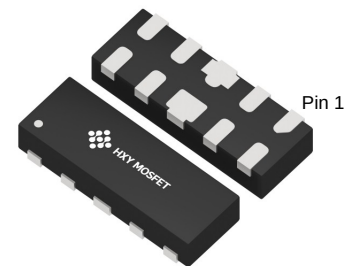




Discription

The PESD4USB3U-TTSX is a 4-channel ultra low capacitance rail clam ESD protection diodes array. Each channel consists of a pair of diodes that steer positive or negative ESD current to either the positive or negative rail. A zener diode is integrated in to the array between the positive and negative supply rails.

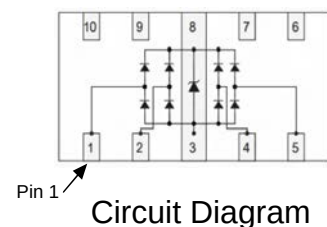
In the typical applications, the negative rail pin (assigned as GND) is connected with system ground. The Positive ESD current is steered to the ground through an ESD diode and Zener diode and the positive ESD voltage is clamped to the zener voltage.



DFN2510-10L
(DFN2510D-10))

Features

- ★ 4 channels of ESD protection;
- ★ Provides ESD protection to IEC61000-4-2 level 4
 - ±15kV air discharge
 - ±10kV contact discharge;
- ★ Channel I/O to GND capacitance: 0.55pF (Max)
- ★ Channel I/O to I/O capacitance: 0.6pF (Max)
- ★ Low clamping voltage;
- ★ Low operating voltage;
- ★ Improved zener structure;
- ★ Optimized package for easy high speed data lines PCB layout;
- ★ RoHS compliant and Halogen Free.



Circuit Diagram

Ordering Information

Product ID	Pack	Qty(PCS)
PESD4USB3U-TTSX	DFN2510-10L(DFN2510D-10))	3000

Absolute Ratings(Tamb = 25°C)

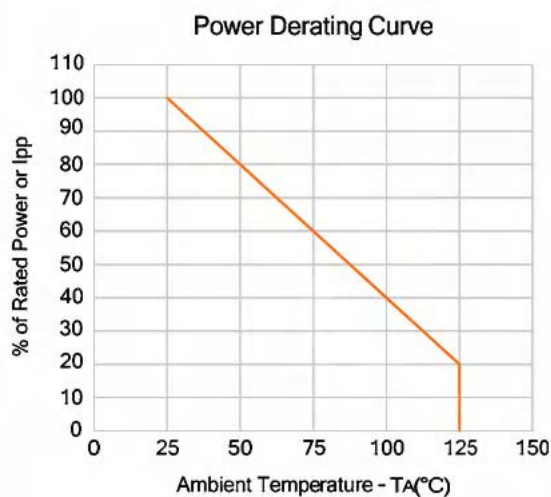
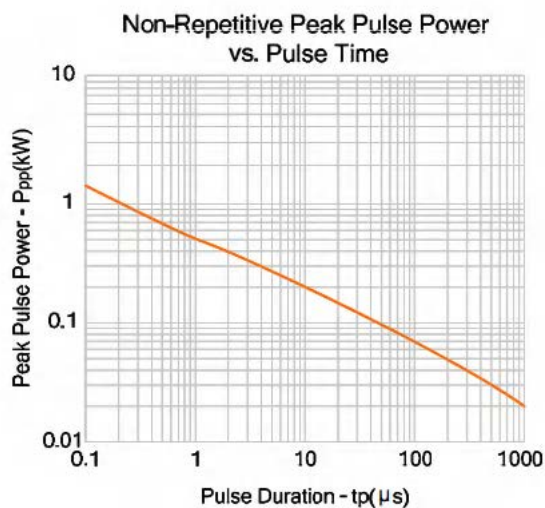
Symbol	Parameter	Value	Units
P _{PP}	Peak Pulse Power (t _p = 8/20μs)	70	W
I _{PP}	Peak Pulse Current(8/20us)	4	A
T _L	Maximum lead temperature for soldering during 10s	260	°C
T _{stg}	Storage Temperature Range	-55 to +150	°C
T _{op}	Operating Temperature Range	-40 to +125	°C
T _j	Maximum junction temperature	150	°C
	IEC61000-4-2 (ESD)	air discharge contact discharge	± 15 ± 10 KV

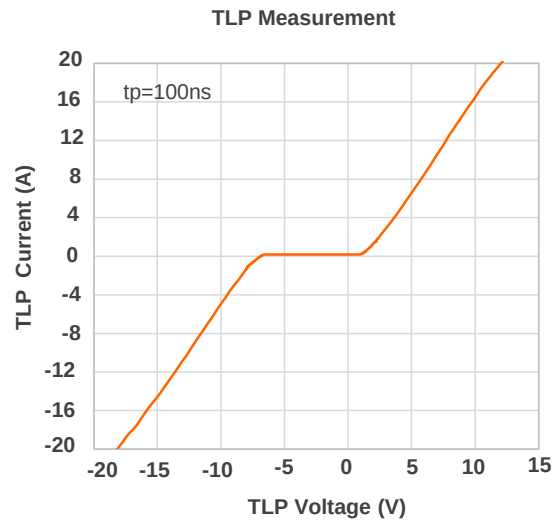
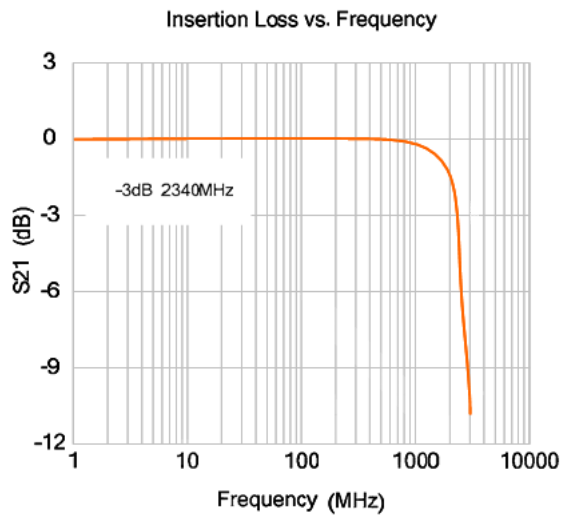
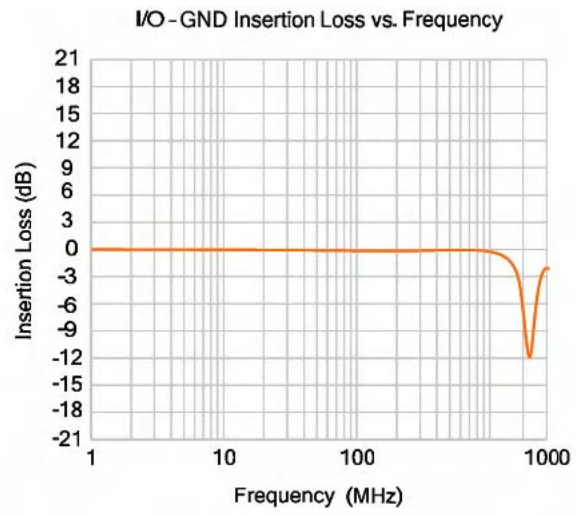
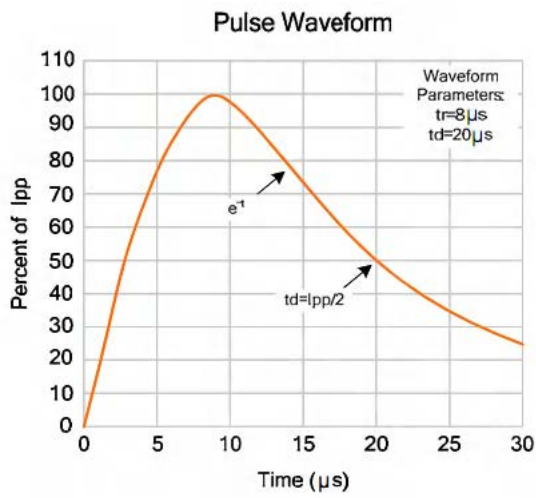


Electrical Characteristics (Ta= 25°C)

Symbol	Parameter	Test Condition	Min	Typ	Max	Units
V_{RWM}	Reverse Working Voltage				3.3	V
V_{BR}	Reverse Breakdown Voltage	$I_T = 1mA$	5.6			V
I_R	Reverse Leakage Current	$V_{RWM} = 5.0V$			1.0	μA
V_C	Clamping Voltage	$I_{RWM} = 1A, t_p = 8/20\mu s$		7		V
		$I_{RWM} = 4A, t_p = 8/20\mu s$		8	20	V
C_J	Junction Capacitance	$V_R = 0V, f = 1MHz$ Any I/O pin to GND		0.5	0.6	pF
C_J	Junction Capacitance	$V_R = 0V, f = 1MHz$ Any I/O pin to I/O		0.3	0.4	pF

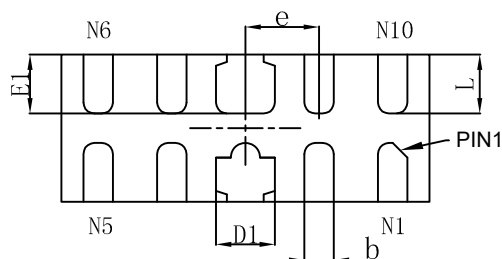
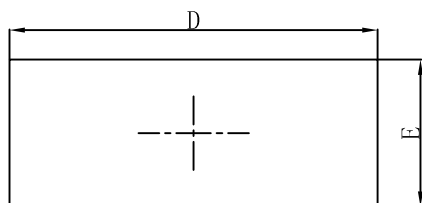
Typical Characteristics



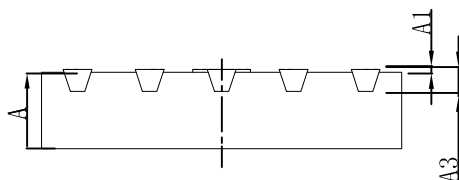




Outline And Dimensions



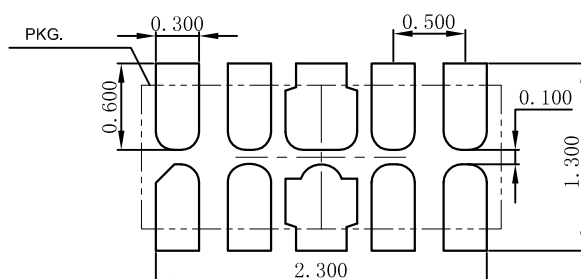
Bottom View



Side View

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.450	0.550	0.017	0.022
A1	0.000	0.050	0.000	0.002
A3	0.152REF.		0.006REF.	
D	2.450	2.550	0.096	0.100
E	0.950	1.050	0.037	0.041
D1	0.350	0.450	0.014	0.018
E1	0.350	0.450	0.014	0.018
b	0.150	0.250	0.006	0.010
e	0.500TYP.		0.020TYP.	
L				

Soledering Footprint





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